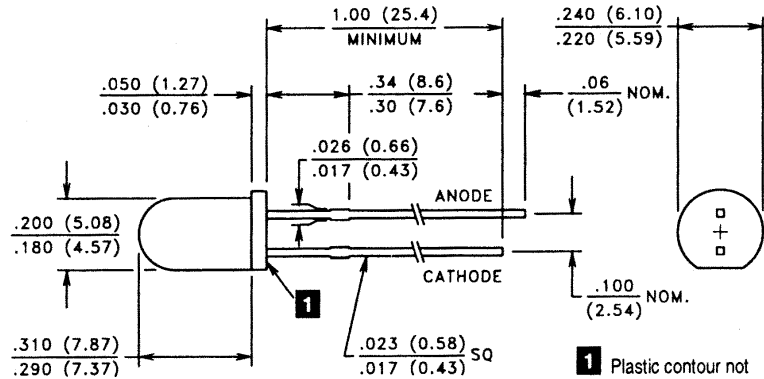




**PACKAGE DIMENSIONS inch (mm)**



**1** Plastic contour not controlled in region of the leads.

CASE 26 T-1¾ (5 mm)  
 CHIP SIZE: .018" x .018"

**DESCRIPTION**

This narrow beam angle 5 mm diameter plastic packaged emitter contains a large area, double wirebonded, GaAlAs, 880 nm, high efficiency IRED chip suitable for higher current pulse applications.

**RoHS Compliant**



**ABSOLUTE MAXIMUM RATINGS @ 25°C (unless otherwise noted)**

Maximum Temperatures		Maximum Reverse Voltage:	5.0V
Storage and Operating:	-40°C to 100°C	Maximum Reverse Current @ $V_R = 5V$ :	10 $\mu A$
Continuous Power Dissipation:	200 mW	Peak Wavelength (Typical):	880 nm
Derate above 30°C:	2.86 mW/°C	Junction Capacitance @ 0V, 1 MHz (Typ.):	35 pF
Maximum Continuous Current:	100 mA	Response Time @ $I_F = 20 mA$	
Derate above 30°C:	1.43 mA/°C	Rise: 1.0 $\mu s$ Fall: 1.0 $\mu s$	
Peak Forward Current, 10 $\mu s$ , 100 pps:	3.0 A	Lead Soldering Temperature:	260°C
Temp. Coefficient of Power Output (Typ.):	-8%/°C	(1.6 mm from case, 5 seconds max.)	

**ELECTRO-OPTICAL CHARACTERISTICS @ 25°C (See also GaAlAs curves, pages 108-110)**

Part Number	Output						Forward Drop		Half Power Beam Angle	
	Irradiance				Radiant Intensity	Total Power	Test Current	$V_F$		
	$E_e$		Condition		$I_e$	$P_O$	$I_{FT}$	@ $I_{FT}$	$\theta_{1/2}$	
	mW/cm <sup>2</sup>		distance	Diameter	mW/sr	mW	mA (Pulsed)	Volts		Typ.
	Min.	Typ.	mm	mm	Min.	Typ.		Typ.	Max.	
VTE1261H	3.0	3.9	36	6.4	39	20	100	1.5	2.0	$\pm 10^\circ$
VTE1262H	4.0	5.2	36	6.4	52	25	100	1.5	2.0	$\pm 10^\circ$

Refer to General Product Notes, page 2.